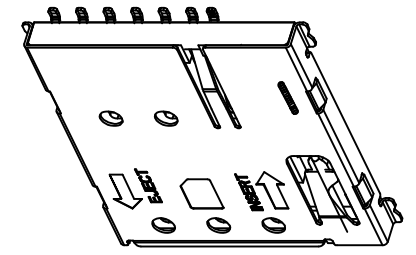
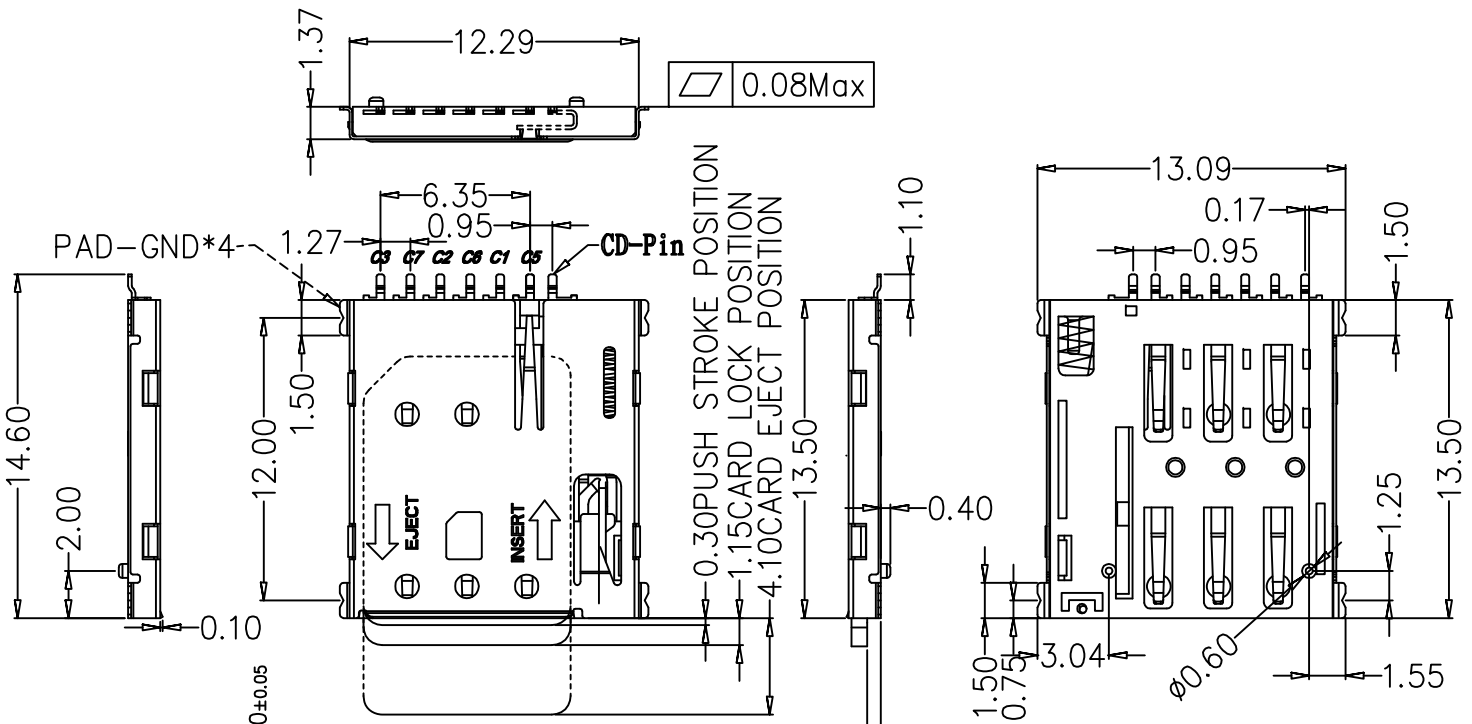


更改 REV	變更內容 MODIFICATION
A	ECXXXX

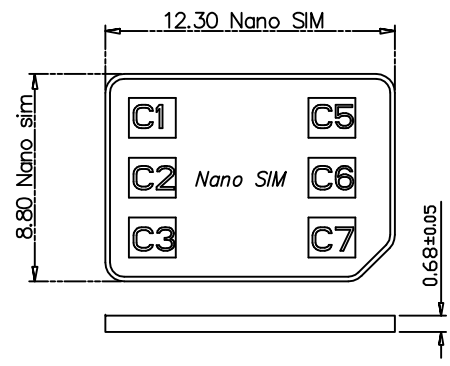


Specification

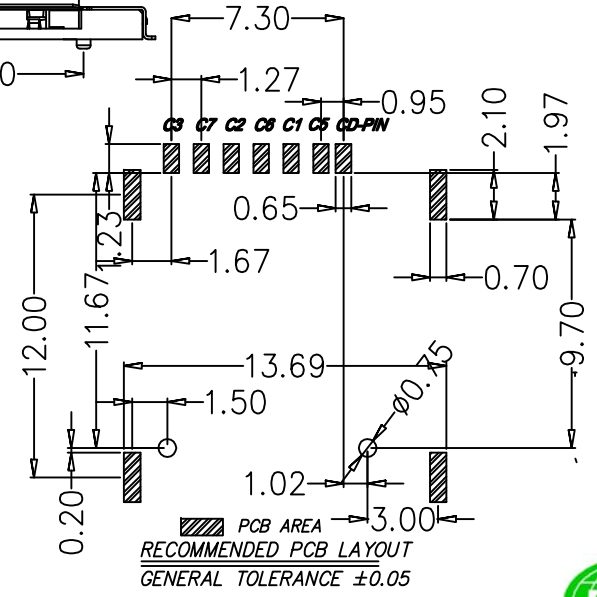
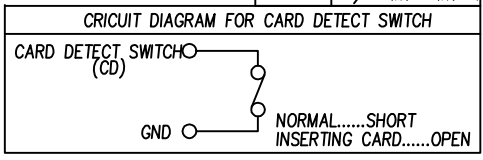
MATERIAL:
 Insulator: High Temperature Thermoplastic UL 94V-0.
 Contact: Copper Alloy
 SHELL: SUS

PLATING:
 Contact: ALL AU GOLD 1U
 Shell: Plated 50u" Ni Overall, PAD Au 1U

Electrical:
 Current Rating :0.5mA AC/DC max.
 Voltage Rating :125V AC/DC
 Ambient Temperature Range :-20° C~+80° C
 Storage Temperature Range :-40° C~+70° C
 Ambient Humidity Range :95% R.H. Max.
 Contact Resistance:100m Ω max.
 Insulation Resistance:1000M Ω min./500VDC
 Mating Cycles:3000 Insertions
 產品耐溫溫度:260度



SIM pin assignment	
PIN#	Name
C1	VCC 供電電壓
C2	RST 重置
C3	CLK 時鐘
C5	GND 接地
C6	VPP 程序電壓
C7	I/O 輸入輸出



GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司
X±0.50	X*±5°	
X±0.30	X*±2°	
.XX±0.20	.XX*±1°	名廠(TITLE)
		SIM 卡座 PUSH/PUSH 1.35H 帶CD PIN
單位(UNIT)	料號(PART NO.)	圖號(DWG NO.)
mm	7SIMC-FA-0021	7SIMC-FA-0021
審核(APPROVAL)	核對(CHECKED)	製圖(DRAWN)
		比例 SCALE 1:1
		張數 SHEET 1/1
		更改 REV A